MURP20020CT, MURP20040CT

Preferred Devices

POWERTAP[™] II Ultrafast SWITCHMODE[™] Power Rectifiers

These state-of-the-art POWERTAP II Ultrafast SWITCHMODE power rectifiers are designed for use in switching power supplies, inverters, and as free wheeling diodes.

Features

- Dual Diode Construction
- Low Leakage Current
- Low Forward Voltage
- 175°C Operating Junction Temperature
- Labor Saving POWERTAP Package
- Pb-Free Packages are Available*

Mechanical Characteristics:

- Case: Epoxy, Molded with Metal Heatsink Base
- Weight: 80 Grams (Approximately)
- Finish: All External Surfaces Corrosion Resistant
- Top Terminal Torque: 25 40 lb–in Max
- Base Plate Torques: See Procedure Given in the Package Outline Section

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage MURP20020CT MURP20040CT	V _{RRM} V _{RWM} V _R	300 400	V
Average Rectified Forward Current @ T _L = 150°C - Per Device @ T _L = 125°C - Per Leg	I _{F(AV)}	200 100	A
Peak Repetitive Surge Current Per Leg (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	IFRM	200	A
Nonrepetitive Peak Surge Current Per Leg (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	IFSM	800	A
Operating Junction Temperature	TJ	–55 to +175	°C
Storage Temperature	T _{stg}	–55 to +150	°C

THERMAL CHARACTERISTICS

Rating	Symbol	Max	Unit
Thermal Resistance, Junction-to-Lead	$R_{\theta JC}$	0.45	°C/W

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

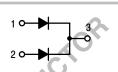
*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



ON Semiconductor®

http://onsemi.com

ULTRAFAST RECTIFIERS 200 AMPERES, 200–400 VOLTS



POWERTAP II CASE 357C PLASTIC

MARKING DIAGRAM

А	=	Assembly Location
YY	=	Year
WW	=	Work Week
G	=	Pb-Free Package
UP200x0	=	Device Code
		x = 2 or 4

ORDERING INFORMATION

Device	Package	Shipping
MURP20020CT	POWERTAP II	25 Units/Tray
MURP20020CTG	POWERTAP II (Pb-Free)	25 Units/Tray
MURP20040CT	POWERTAP II	25 Units/Tray
MURP20040CTG	POWERTAP II (Pb-Free)	25 Units/Tray

Preferred devices are recommended choices for future use and best overall value.

MURP20020CT, MURP20040CT

ELECTRICAL CHARACTERISTICS (Per Leg)

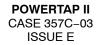
Rating	Symbol	MURP20020CT	MURP20040CT	Unit
Instantaneous Forward Voltage (Note 1) ($i_F = 100 \text{ A}, T_C = +25^{\circ}\text{C}$) ($i_F = 200 \text{ A}, T_C = 25^{\circ}\text{C}$) ($i_F = 100 \text{ A}, T_C = 125^{\circ}\text{C}$)	v _F	1.00 1.10 0.95	1.30 1.75 1.15	V
Instantaneous Reverse Current (Note 1) (Rated DC Voltage, $T_C = 125^{\circ}C$) (Rated DC Voltage, $T_C = 25^{\circ}C$)	İR	1000 150	500 50	μΑ
Maximum Reverse Recovery Time (I _F = 1.0 A, di/dt = 50 A/μs)	t _{rr}	50	75	ns

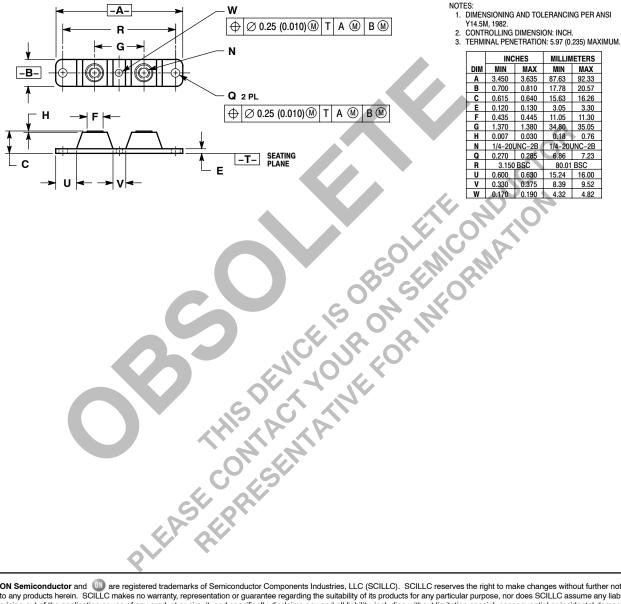
1. Pulse Test: Pulse Width = 300 μ s, Duty Cycle \leq [2.0%.



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PACKAGE DIMENSIONS





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